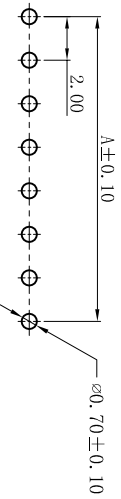
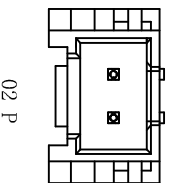
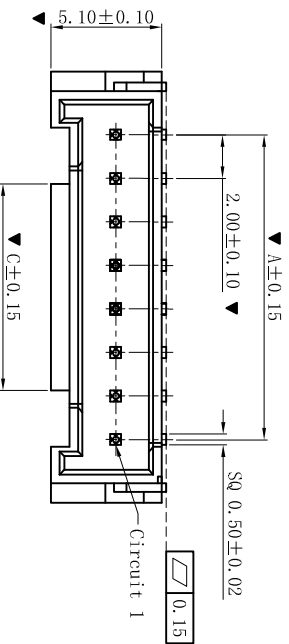
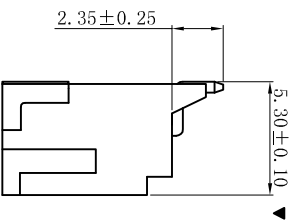
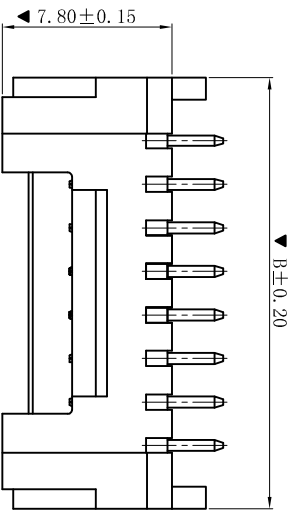


ROHS



SUGGESTED PCB LAYOUT  
(COMPONENT SIDE)

■ SPECIFICATIONS

- Voltage rating: 125V AC, DC
- Current rating: 2A, AC, DC
- Withstanding Voltage: 1000V AC/minute
- Insulation resistance: 1000MΩ min
- Temperature range: -25° C~+85° C
- Contact resistance: 20mΩ max

■ WAFER

- Part No.: W2007SR-NP
- Poles : 02-15P
- Wafer Material: LCP UL94V-0
- Pin Material: Brass
- Solder Tab: Brass/Tin-Plated
- Contact Area Plating: Tin-Plated
- The Dimension Marked “▲” Must Be Recorded

Poles	Dimensions (mm)		
	A	B	C
02	2.00	7.80	2.80
03	4.00	9.80	3.20
04	6.00	11.80	3.50
05	8.00	13.80	5.50
06	10.00	15.80	7.50
07	12.00	17.80	9.50
08	14.00	19.50	11.50
09	16.00	21.80	13.50
10	18.00	23.80	15.50
11	20.00	25.80	15.50
12	22.00	27.80	15.50
13	24.00	29.80	15.50
14	26.00	31.80	15.50
15	28.00	33.80	15.50

一般公差 GENERAL TOLERANCE:	0±0.30 .0±0.25 .00±0.20 .000±0.05
ANGLE: ±1°	

**XYDZ® 东莞市祥运连接器有限公司**  
Dongguan XiangYun Connectors CO., Ltd

投影法 Projection		品名 (PART NAME)	YH2_00mm SMT 90° Wafer
单位 Unit	MM	料号 (PART NO)	W2007SR-NP
比例/Scale	1:1	状态码	C
大小/Size	A4		
页码/SHEET	1/1		
版本/Rev	B		

更新图面 新版本	2019-06-03	2019-06-03	陈雄军	胡进
说明 DESCRIPTION	2017-07-17	2019-06-03	Jeff	胡进
承认 APPRO.				

日期 DATE:	2019-06-03
承认 APPRO.	

1 2 3 4 5 6 7 8 9 10